TOSHIBA Field Effect Transistor Silicon N-Channel MOS Type (π-MOS V)

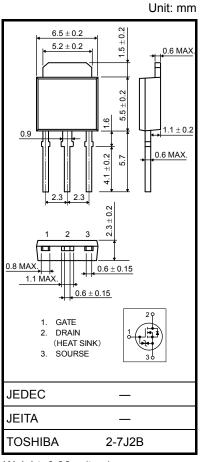
2SK4020

Chopper Regulators, DC-DC Converters and Motor Drive Applications

- 4-V gate drive
- Low drain-source ON-resistance: $R_{DS (ON)} = 0.56 \Omega$ (typ.)
- High forward transfer admittance: |Y_{fs}| = 4.5 S (typ.)
- Low leakage current: $I_{DSS} = 100 \ \mu A \ (max) \ (V_{DS} = 200 \ V)$
- Enhancement mode: V_{th} = 1.5 to 3.5 V (V_{DS} = 10 V, I_D = 1 mA)

Absolute Maximum Ratings (Ta = 25°C)

Characteri	stic	Symbol	Rating	Unit
Drain-source voltage		V _{DSS}	200	V
Drain-gate voltage (R	_{GS} = 20 kΩ)	V _{DGR}	200	V
Gate-source voltage		V _{GSS}	±20	V
Drain current	DC (Note 1)	۱ _D	5	А
	Pulse (Note 1)	I _{DP}	20	А
Drain power dissipation	n (Tc = 25°C)	PD	20	W
Single-pulse avalanche	e energy (Note 2)	E _{AS}	65	mJ
Avalanche current		I _{AR}	5	А
Repetitive avalanche e	nergy (Note 3)	E _{AR}	2	mJ
Channel temperature		T _{ch}	150	°C
Storage temperature ra	ange	T _{stg}	−55 to 150	°C



Weight: 0.36 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high

temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

Characteristic	Symbol	Мах	Unit	
Thermal resistance, channel to case	R _{th (ch-c)}	6.25	°C / W	
Thermal resistance, channel to ambient	R _{th (ch−a)}	125	°C / W	

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: V_{DD} = 50 V, T_{ch} = 25°C (initial), L = 4.2 mH, R_G = 25 Ω , I_{AR} = 5 A

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device. Handle with care.

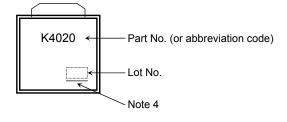
Electrical Characteristics (Ta = 25°C)

Chara	cteristic	Symbol	Test Condition	Min	Тур.	Мах	Unit
Gate leakage cu	e leakage current I_{GSS} $V_{GS} = \pm 16 V, V_{DS} = 0 V$		_	_	±10	μA	
Drain cutoff curr	rent	I _{DSS}	V _{DS} = 200 V, V _{GS} = 0 V	_	_	100	μA
Drain-source br	eakdown voltage	V (BR) DSS	I _D = 10 mA, V _{GS} = 0 V	200	_	—	V
Gate threshold	voltage	V _{th}	V _{DS} = 10 V, I _D = 1 mA	1.5	_	3.5	V
Drain-source O	N-resistance	R _{DS (ON)}	V _{GS} = 10 V, I _D = 2.5 A	_	0.56	0.8	Ω
Forward transfe	r admittance	Y _{fs}	V _{DS} = 10 V, I _D = 2.5 A	2.0	4.5	—	S
Input capacitance	citance C_{iSS} ansfer capacitance C_{rSS} V_{DS} = 10 V, V_{GS} = 0 V, f = 1 MHz		_	440	—	pF	
Reverse transfe			_	35	—		
Output capacitance		C _{oss}			120		—
Switching time	Rise time	tr	$V_{GS} \stackrel{10 \text{ V}}{}_{0 \text{ V}} \stackrel{I_{D}}{\underset{50\Omega}{}_{\ast}} \stackrel{I_{D}}{\underset{50\Omega}{}_{\ast}} \stackrel{2.5 \text{ A}}{\underset{V_{DD}}{}_{\circ}} \stackrel{V_{out}}{\underset{V_{DD}}{}_{\ast}} \stackrel{V_{out}}{\underset{V_{DD}}{}_{\ast}} \stackrel{I_{D}}{\underset{V_{out}}{}_{\ast}} \stackrel{I_{D}}{\underset{V_{D}}{}_{\ast}} \stackrel{I_{D}}{\underset{V_{D}}{}_{\ast}} \stackrel{I_{D}}{\underset{V_{out}}{}_{\ast}} \stackrel{I_{D}}{\underset{V_{D}}{}_{\ast}} \stackrel{I_{D}}{\underset{V}}{}_{\ast}} \stackrel{I_{D}}{\underset{V_{D}}{}_{\ast}} \stackrel{I_{D}}{\underset{V_{D}}{}_{\ast}} \stackrel{I_{D}}{\underset{V}} \stackrel{I_{D}}{\underset{V}} \stackrel{I_{D}}{\underset{V}}{}_{\ast}} \stackrel{I_{D}}{\underset{V}}{}_{\ast} \stackrel{I_{D}}{\underset{V}} \stackrel{I_{D}}{\underset{V}}{} \stackrel{I_{D}}{\underset{V}}{}_{\ast}} \stackrel{I_{D}}{\underset{V}} \stackrel{I_{D}}{\underset{V}}{\underset{V}} \stackrel{I_{D}}{\underset{V}} \stackrel{I_{D}}{\underset{V}}} \stackrel{I_{D}}{\underset{V}}{} \stackrel{I_{D}}{\underset{V}} \stackrel{I_{D}}{\underset{V}} \stackrel{I_{D}}{\underset{V}} \stackrel{I_{D}}{\underset{V}}} \stackrel{I_{D}}{\underset{V}} \stackrel{I_{D}}}{\underset{V}} \stackrel{I_{D}}{\underset{V}} \stackrel{I_{D}}{\underset{V}} I_{$	_	15	_	ns
	Turn-on time	t _{on}		_	20	_	
	Fall time	t _f		_	15	_	
	Turn-off time	t _{off}		_	60	_	
Total gate charge (gate-source plus gate-drain)		Qg		_	10	—	
Gate-source charge		Q _{gs}	$V_{DD} \approx 100 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 5 \text{ A}$		6	_	nC
Gate-drain ("Miller") Charge		Q _{gd}]	—	4	—	

Source–Drain Ratings and Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I _{DR}	—	_	_	5	А
Pulse drain reverse current (Note 1)	I _{DRP}	—	_	_	20	А
Forward voltage (diode)	V _{DSF}	I _{DR} = 5 A, V _{GS} = 0 V	_	_	-2.0	V
Reverse recovery time	t _{rr}	I_{DR} = 5 A, V_{GS} = 0 V, dI_{DR} / dt = 100 A / μ s		150	_	ns
Reverse recovery charge	Q _{rr}			0.45		μC

Marking

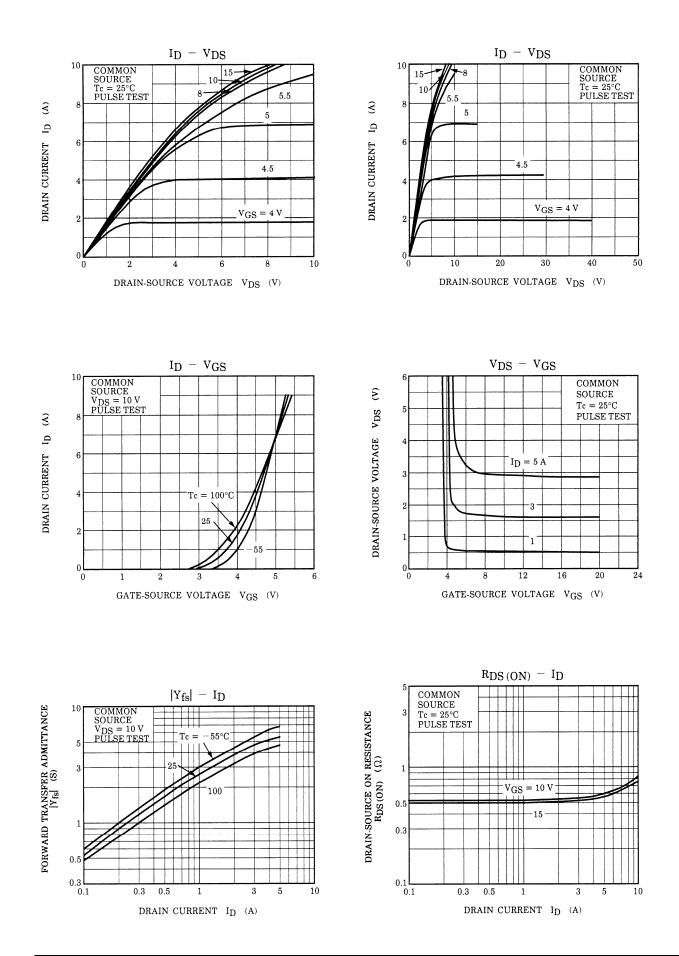


Note 4: A line under a Lot No. identifies the indication of product Labels.

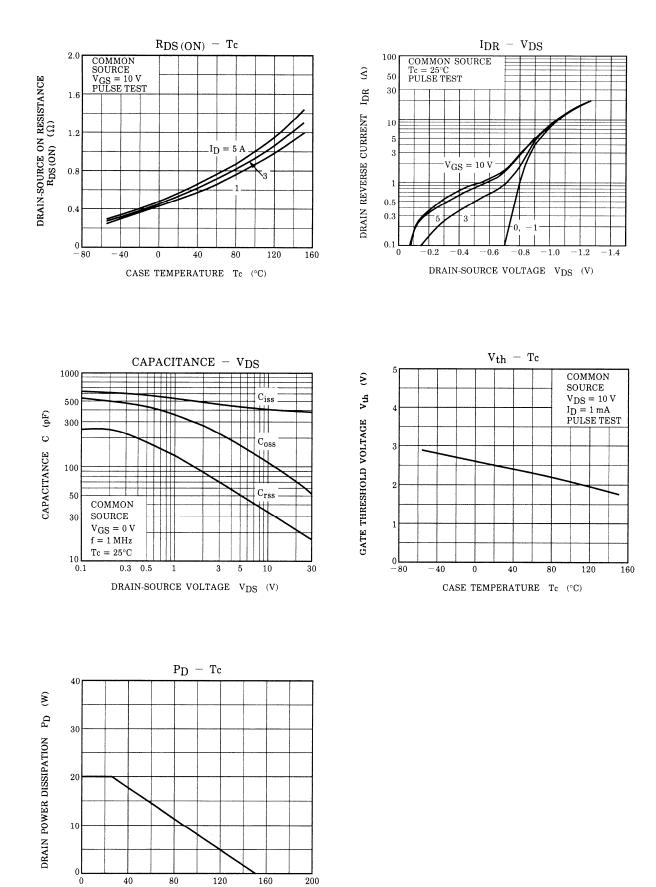
[[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

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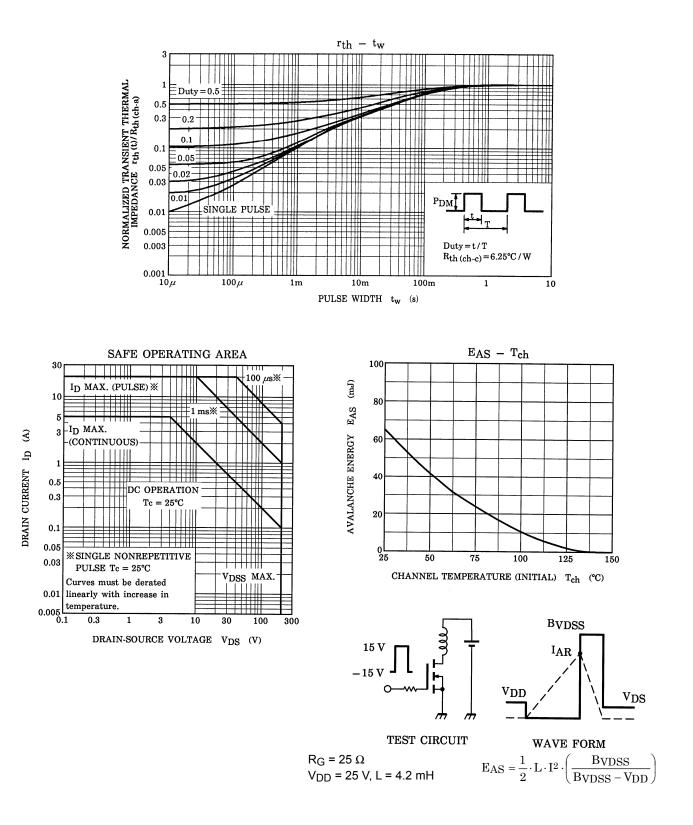
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CASE TEMPERATURE Tc (°C)



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